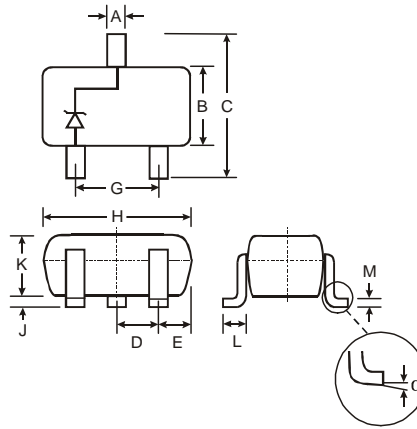


Features

- Planar Die Construction
- Ultra-Small Surface Mount Package
- General Purpose
- Ideally Suited for Automated Assembly Processes
- **Lead Free/RoHS Compliant (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **"Green" Device, Note 3 and 4**

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 7. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 3
- Weight: 0.006 grams (approximate)



SOT-323		
Dim	Min	Max
A	0.25	0.40
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.18
α	0°	8°
All Dimensions in mm		

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward Voltage @ I _F = 10mA	V _F	0.9	V
Power Dissipation (Note 1)	P _d	200	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	R _{θJA}	625	°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	°C

* Add "-7-F" to the appropriate type number in Table 1 from Sheet 2 example: 6.2V Zener = MMBZ5234BW-7-F.

- Notes:
1. Mounted on FR4 PC Board with recommended pad layout which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 2. No purposefully added lead.
 3. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 4. Product manufactured with date code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

Electrical Characteristics @T_A = 25°C unless otherwise specified

Type Number	Marking Code	Zener Voltage Range (Note 5)			Test Current	Maximum Zener Impedance (Note 6)		Maximum Reverse Leakage Current (Note 5)	
		V _Z @ I _{ZT}			I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK} = 0.25mA	I _R	@ V _R
		Nom (V)	Min (V)	Max (V)	mA	Ω		μA	V
MMBZ5221BW	KC1	2.4	2.28	2.52	20	30	1200	100	1.0
MMBZ5223BW	KC3	2.7	2.57	2.84	20	30	1300	75	1.0
MMBZ5225BW	KC5	3.0	2.85	3.15	20	30	1600	50	1.0
MMBZ5226BW	KG1	3.3	3.14	3.47	20	28	1600	25	1.0
MMBZ5227BW	KG2	3.6	3.42	3.78	20	24	1700	15	1.0
MMBZ5228BW	KG3	3.9	3.71	4.10	20	23	1900	10	1.0
MMBZ5229BW	KG4	4.3	4.09	4.52	20	22	2000	5.0	1.0
MMBZ5230BW	KG5	4.7	4.47	4.94	20	19	1900	5.0	2.0
MMBZ5231BW	KE1	5.1	4.85	5.36	20	17	1600	5.0	2.0
MMBZ5232BW	KE2	5.6	5.32	5.88	20	11	1600	5.0	3.0
MMBZ5234BW	KE4	6.2	5.89	6.51	20	7.0	1000	5.0	4.0
MMBZ5235BW	KE5	6.8	6.46	7.14	20	5.0	750	3.0	5.0
MMBZ5236BW	KF1	7.5	7.13	7.88	20	6.0	500	3.0	6.0
MMBZ5237BW	KF2	8.2	7.79	8.61	20	8.0	500	3.0	6.5
MMBZ5239BW	KF4	9.1	8.65	9.56	20	10	600	3.0	7.0
MMBZ5240BW	KF5	10	9.50	10.50	20	17	600	3.0	8.0
MMBZ5241BW	KH1	11	10.45	11.55	20	22	600	2.0	8.4
MMBZ5242BW	KH2	12	11.40	12.60	20	30	600	1.0	9.1
MMBZ5243BW	KH3	13	12.35	13.65	9.5	13	600	0.5	9.9
MMBZ5245BW	KH5	15	14.25	15.75	8.5	16	600	0.1	11
MMBZ5246BW	KJ1	16	15.20	16.80	7.8	17	600	0.1	12
MMBZ5248BW	KJ3	18	17.10	18.90	7.0	21	600	0.1	14
MMBZ5250BW	KJ5	20	19.00	21.00	6.2	25	600	0.1	15
MMBZ5251BW	KK1	22	20.90	23.10	5.6	29	600	0.1	17
MMBZ5252BW	KK2	24	22.80	25.20	5.2	33	600	0.1	18
MMBZ5254BW	KK4	27	25.65	28.35	5.0	41	600	0.1	21
MMBZ5255BW	KK5	28	26.60	29.40	4.5	44	600	0.1	21
MMBZ5256BW	KM1	30	28.50	31.50	4.2	49	600	0.1	23
MMBZ5257BW	KM2	33	31.35	34.65	3.8	58	700	0.1	25
MMBZ5258BW	KM3	36	34.20	37.80	3.4	70	700	0.1	27
MMBZ5259BW	KM4	39	37.05	40.95	3.2	80	800	0.1	30

- Notes: 5. Short duration pulse test used to minimize self-heating effect.
6. f = 1KHz.

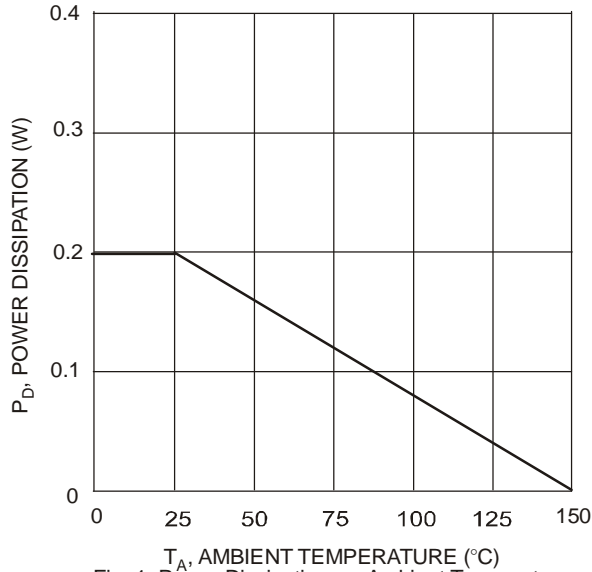


Fig. 1 Power Dissipation vs. Ambient Temperature

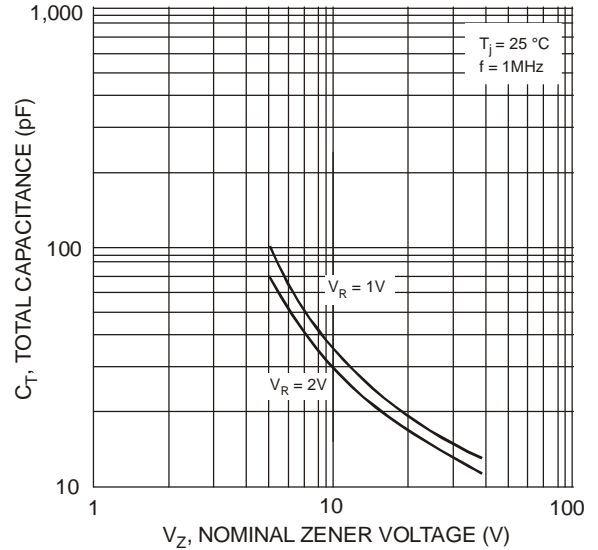


Fig. 2 Total Capacitance vs. Nominal Zener Voltage

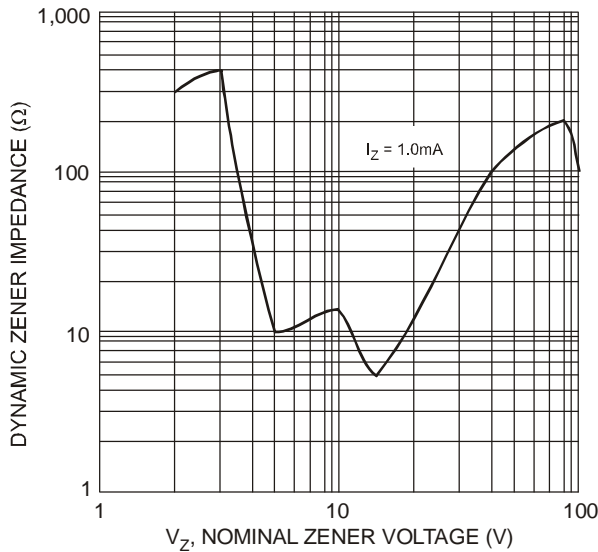


Fig. 3 Zener Voltage vs. Zener Impedance

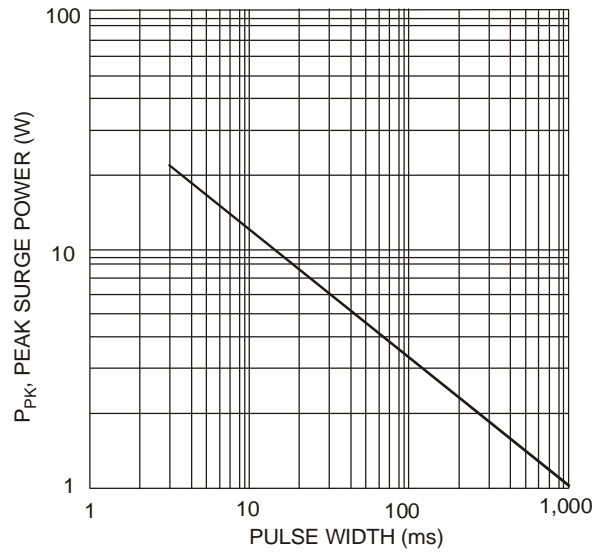


Fig. 4 Maximum Non-repetitive Surge Power

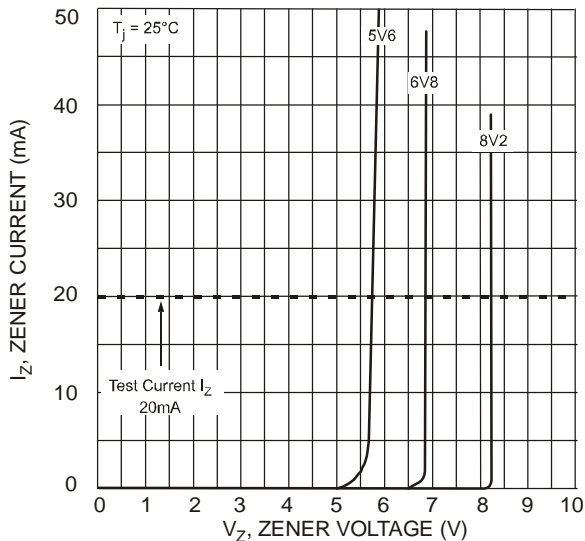


Fig. 5 Zener Breakdown Characteristics

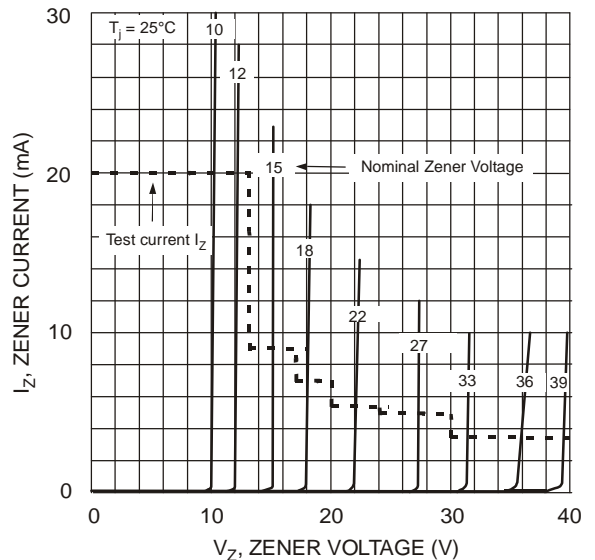


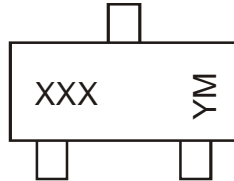
Fig. 6 Zener Breakdown Characteristics

Ordering Information (Notes 4 and 7)

Device	Packaging	Shipping
(Type Number)-7-F	SOT-323	3000/Tape & Reel

Notes: 7. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



XXX = Product Type Marking Code, See Table on Page 2

YM = Date Code Marking

Y = Year ex: N = 2002

M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	M	N	P	R	S	T	U	V	W	X	Y	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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